

●特点:热阻低 开关速度快 输入阻抗高 符合RoHS规范

● FEATURES: ■LOW THERMAL RESISTANCE ■ FAST SWITCHING ■ HIGH INPUT RESISTANCE

■RoHS COMPLIANT

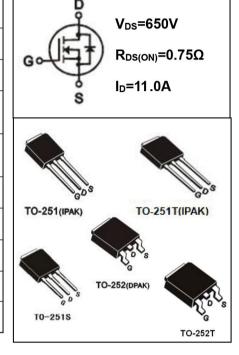
●应用: 电子镇流器 电子变压器 开关电源

● APPLICATION: ■ ELECTRONIC BALLAST ■ ELECTRONIC TRANSFORMER ■ SWITCH MODE POWER SUPPLY

●最大额定值(TC=25°C)

●Absolute Maximum Ratings(Tc=25°C)TO-251T/TO-251S/252/252T

Absolute Maxillium Ratings	(10 20 0)	10-2011/10-2	010/20
参数 PARAMETER	符号 SYMBOL	额定值 VALUE	单位 UNIT
漏-源电压 Drain-source Voltage	$V_{ extsf{DS}}$	650	٧
栅-源电压 gate-source Voltage	V_{GS}	±30	٧
漏极电流 Continuous Drain Current TC=25℃	l _D	11	А
漏极电流 Continuous Drain Current TC=100℃	I _D	6.0	А
最大脉冲电流 Drain Current 一Pulsed ①	I _{DM}	40	Α
耗散功率 Power Dissipation	P _{tot}	50	W
最高结温 Junction Temperature	Tj	150	°C
存储温度 Storage Temperature	T_{STG}	-55-150	°C
单脉冲雪崩能量 Single Pulse Avalanche Energy ②	E _{AS}	510	mJ



●电特性(Tc=25°C)

● Electronic Characteristics (Tc=25°C)

参数 PARAMETER	符号 SYMBOL	测试条件 TEST CONDITION	最小值 MIN	典型值 TYP	最大值 MAX	单位 UNIT
漏-源击穿电压 Drain-source Breakdown Voltage	BV _{DSS}	$V_{GS}\text{=}0V,\ I_{D}\text{=}250\mu\text{A}$	650			V
击穿电压温度系数 Breakdown Voltage Temperature Coefficient	ΔBV _{DSS/} Δ Tj	I _D =250uA, Referenced to 25°C		0.65		V/°C
栅极开启电压 Gate Threshold Voltage	V _{GS(TH)}	V _{GS} =V _{DS} , I _D =250μA	2.0		4.0	V
漏-源漏电流 Drain-source Leakage Current	V _{DS} =650V, V _{GS} =0V, Tj=25°C			1	μΑ	
	IDSS	V _{DS} =480V, V _{GS} =0V, Tj=125°C			10	μА
跨导 Forward Transconductance	gfs	$V_{DS} = 15 \text{V}, I_{D} = 5.0 \text{A}$		7.0		S



参数 PARAMETER	符号 SYMBOL	测试条件 TEST CONDITION	最小值 MIN	典型值 TYP	最大值 MAX	单位 UNIT
栅极漏电流 Gate-body Leakage Current (V _{DS} = 0)	I _{GSS}	V _{GS} =±30V			±100	nA
漏-源导通电阻 Static Drain-source On Resistance	R _{ds(on)}	V _{GS} =10V, I _D =5.0A ③		0.75	0.95	Ω
输入电容 Input Capacitance	Ciss			1650		
输出电容 Output Capacitance	Coss	V _{GS} = 0V, V _{DS} = 25V F = 1.0MHZ		150		pF
反馈电容 Feedback Capacitance	Crss			7		
关断延迟 Turn -Off Delay Time	Td(off)	V_{DD} =325V, I_{D} =10.0A R_{G} =25 Ω ③		50		ns
栅极电荷 Total Gate Charge	Qg	I _D =10.0A, V _{DS} = 520V V _{GS} = 10V ③		32		nC
栅源电荷 Gate-to-Source Charge	Qgs			9		nC
栅漏电荷 Gate-to-Drain Charge	Qgd)		10		nC
二极管正向电流 Continuous Diode Forward Current	ls				11.0	Α
二极管正向压降 Diode Forward Voltage	V _{SD}	Tj=25°C, Is=10.0A V _{GS} =0V			1.4	V
反向恢复时间 Reverse Recovery Time	trr	Tj=25°C,lf=10.0A		365		ns
反向恢复电荷 Reverse Recovery Charge	Qrr	di/dt=100A/µs ③		3.4		uC

●热特性

●Thermal Characteristics

参数 PARAMETER	符号 SYMBOL	最大值 MAX	单位 UNIT
热阻结-壳 Thermal Resistance Junction-case	RthJc	2.50	°C/W
热阻结-环境 Thermal Resistance Junction-ambient	Rth _{JA}	62.5	°C/W

注释(Notes):

① 脉冲宽度: 以最高节温为限制

Repetitive rating: Pulse width limited by maximum junction temperature

② 初始结温=25°C, V_{DD} =50V, L=16mH, R_G =25 Ω , I_{AS} =8.0A Starting Tj=25°C, V_{DD} =50V, L=16mH, R_G =25 Ω , I_{AS} =8.0A

③ 脉冲测试: 脉冲宽度≤300μs , 占空比≤2 %

Pulse Test : Pulse width $\leq 300\mu s$, Duty cycle $\leq 2\%$



● 特性曲线

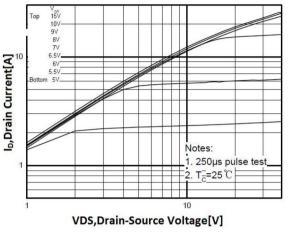


图 1 输出特性曲线, Tc=25℃ Fig1 Typical Output Characteristics, Tc=25℃

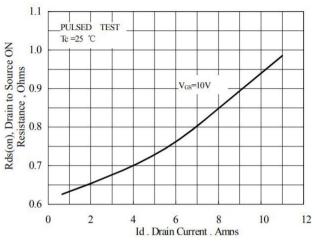


图 2 导通电阻与漏极电流和栅极电压曲线 Fig2 On-Resistance Vs.Drain Current and Gate Voltage

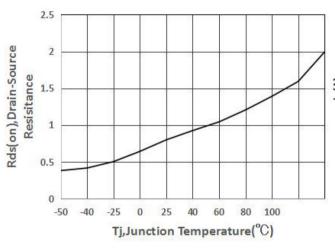


图 3 导通电阻与温度曲线

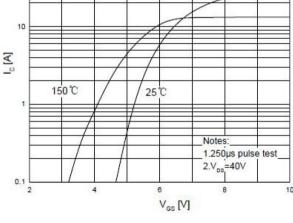
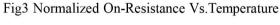


图 4 二极管正向电压曲线



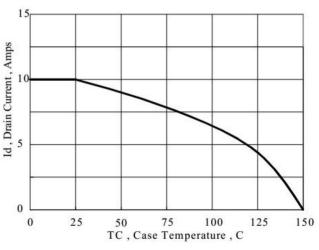


图 5 最大漏极电流与壳温曲线

Fig5 Maximum Drain Current Vs.Case Temperature

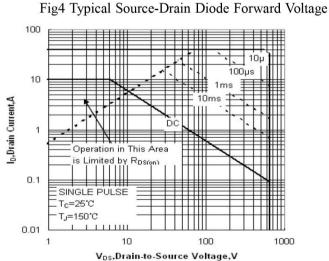


图 6 最大安全工作区曲线

Fig6 Maximum Safe Operating Area

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